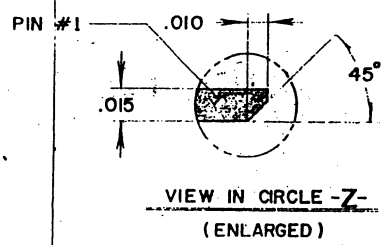
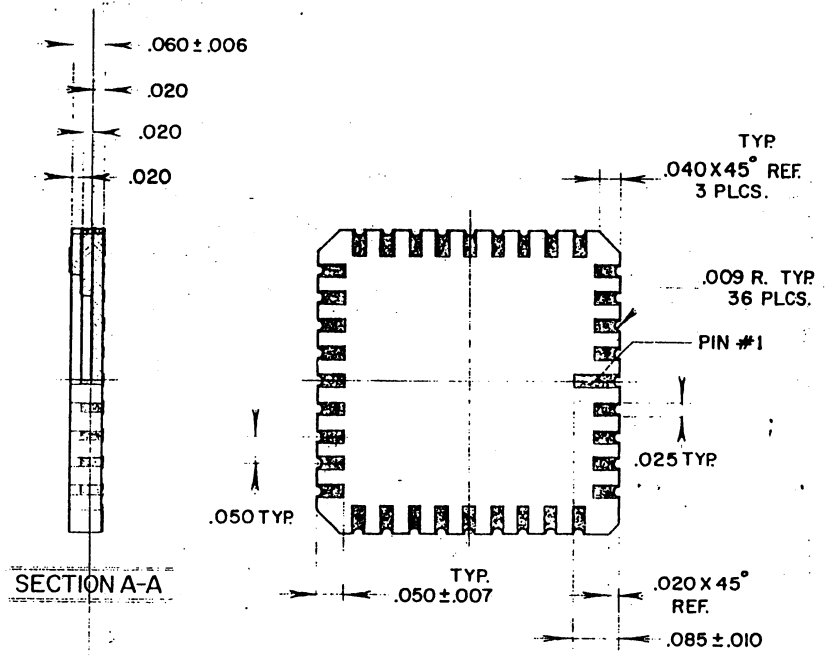
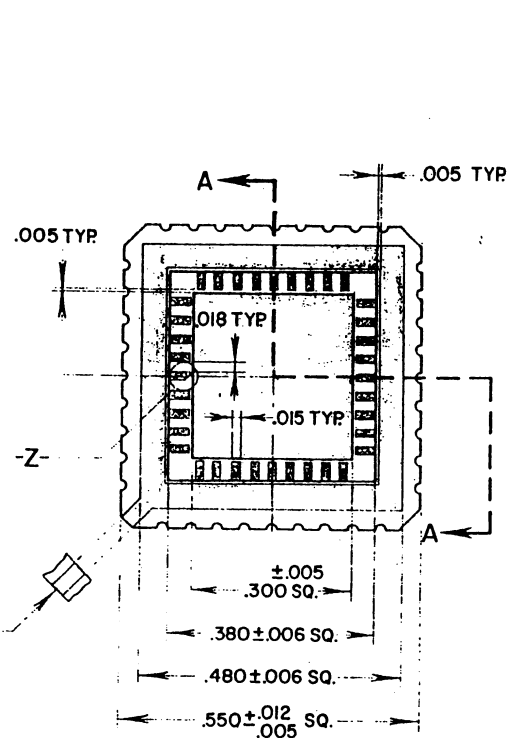


SSM P/N LCC03606



NOTES:

- 1 METALLIZATION/PLATING:
REFRACTORY METAL WITH MINIMUM 50μ NIKEL UNDER MINIMUM 60μ GOLD UNLESS SPECIFIED IN PURCHASE ORDER.
- 2 SEAL RING AND DIE ATTACH PAD ARE NOT CONNECTED TO ANY LEAD.

TOLERANCE UNLESS SPECIFIED	SCALE 5X	 INTERNATIONAL, INC. 8011 BALBOA AVENUE SAN DIEGO, CALIFORNIA 92123	NAME 36 LEAD CHIP CARRIER
$\pm 1\%$ NLT .005	DATE 10-05-82		MATERIAL KYOCERA SA-4303 BTAC
	DRAWN BY M. K. ...		PROJECT 81R-6-1/A/B
	APPROVED BY ...		FIG. NO. 80-010-0210

